Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Reza Arghavani	01/12/2007
Ellie Yieh	01/12/2007
Hichem M'Saad	01/18/2007

RECEIVING PARTY DATA

Name:	Applied Materials, Inc.	
Street Address:	P. O. Box 450A	
City:	Santa Clara	
State/Country:	CALIFORNIA	
Postal Code:	95052	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11609851

CORRESPONDENCE DATA

(408)986-3090 Fax Number:

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Email: barbara_holt@amat.com

Correspondent Name: **Applied Materials** Address Line 1: P.O. Box 450A

Address Line 4: Santa Clara, CALIFORNIA 95052

ATTORNEY DOCKET NUMBER:	10684/DSM/HDP/CVD
NAME OF SUBMITTER:	Barbara Holt

Total Attachments: 4

source=10684 _ASG 013007#page1.tif source=10684 _ASG 013007#page2.tif source=10684 _ASG 013007#page3.tif

REEL: 018825 FRAME: 0537

PATENT 500215491

source=10684 _ASG 013007#page4.tif

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

- 1) Reza Arghavani
 A citizen of the United States of America,
 192 Twin Pines Drive
 Scotts Valley, CA 95066
 U.S.A.;
- 2) Ellie Yieh
 A citizen of the United States of America,
 5888 Pistola Way
 San Jose, CA 95138
 U.S.A.; and
- 3) Hichem M'Saad A citizen of the United States of America, 3500 Granada Ave #364 Santa Clara, CA 95051 U.S.A.

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"MEMORY CELL HAVING STRESSED LAYERS

- [] which is attached hereto
- [X] for which application for Letters Patent in the United States was filed on December 12, 2006, under Serial No. 11/609,851, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title, and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates, and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer, and convey to Assignee the full and exclusive right, title, and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

O:\Legal-Share\IP\Applications As Filed\106xx\10684\10684\assignment.doc

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title, and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title, and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions, and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives, and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	Jan 12, 07 Date	Reza ARGHAVANI
2)	Date	Ellie YIEH
3)	Date 1(18/6)	Hichem M'SAAD

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

- 1) Reza Arghavani
 A citizen of the United States of America,
 192 Twin Pines Drive
 Scotts Valley, CA 95066
 U.S.A.;
- Ellie Yieh
 A citizen of the United States of America, 5888 Pistola Way
 San Jose, CA 95138
 U.S.A.; and
- 3) Hichem M'Saad A citizen of the United States of America, 3500 Granada Ave #364 Santa Clara, CA 95051 U.S.A.

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"MEMORY CELL HAVING STRESSED LAYERS

- [] which is attached hereto
- [X] for which application for Letters Patent in the United States was filed on December 12, 2006, under Serial No. 11/609,851, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title, and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates, and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer, and convey to Assignee the full and exclusive right, title, and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title, and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title, and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions, and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives, and assigns.
- Said Assignors hereby warrant and represent that they have not entered and will not 4. enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)		
.,	Date	Reza ARGHAVANI
2)	<u></u>	Em MELL
	Date	Ellie YIEH
3)		
,	Date	Hichem M'SAAD

O:\Legal-Share\IP\Applications As Filed\106xx\10684\10684\assignment.doc

RECORDED: 01/30/2007